This international standard was developed in accordance with internationally recognized principles on standardization established in the Decision on Principles for the Development of International Standards, Guides and Recommendations issued by the World Trade Organization Technical Barriers to Trade (TBT) Committee.



Designation: D3308 - 12 (Reapproved 2022)

Standard Specification for PTFE Resin Skived Tape¹

This standard is issued under the fixed designation D3308; the number immediately following the designation indicates the year of original adoption or, in the case of revision, the year of last revision. A number in parentheses indicates the year of last reapproval. A superscript epsilon (ε) indicates an editorial change since the last revision or reapproval.

This standard has been approved for use by agencies of the U.S. Department of Defense.

1. Scope

1.1 This specification covers skived tape in thicknesses from 0.013 to 6.35 mm (0.0005 to 0.250 in.) manufactured by skiving (Note 1) from PTFE resin molding and extrusion materials.

Note 1—Skiving is the process of continuously shaving a film on a lathe from the outer surface to the core of a molded cylindrical tube of material.

NOTE 2—Abbreviations have been approved from Terminology D1600.

1.2 The values stated in inch-pound units are to be regarded as standard. The values given in parentheses are for information only.

1.3 The following hazard caveat pertains only to the test method portion, Section 8, of this specification: *This standard does not purport to address all of the safety concerns, if any, associated with its use. It is the responsibility of the user of this standard to establish appropriate safety, health, and environmental practices and determine the applicability of regulatory limitations prior to use.*

Note 3—This specification and ISO 13000-1 and ISO 13000-2 differ in approach or detail, and data obtained using either may not be technically equivalent.

1.4 This international standard was developed in accordance with internationally recognized principles on standardization established in the Decision on Principles for the Development of International Standards, Guides and Recommendations issued by the World Trade Organization Technical Barriers to Trade (TBT) Committee.

2. Referenced Documents

2.1 ASTM Standards:² D149 Test Method for Dielectric Breakdown Voltage and Dielectric Strength of Solid Electrical Insulating Materials at Commercial Power Frequencies

- D374 Test Methods for Thickness of Solid Electrical Insulation (Metric) D0374_D0374M
- D618 Practice for Conditioning Plastics for Testing
- D638 Test Method for Tensile Properties of Plastics
- D792 Test Methods for Density and Specific Gravity (Relative Density) of Plastics by Displacement
- D882 Test Method for Tensile Properties of Thin Plastic Sheeting
- **D883** Terminology Relating to Plastics
- D1389 Test Method for Proof-Voltage Testing of Thin Solid Electrical Insulating Materials (Withdrawn 2013)³
- D1600 Terminology for Abbreviated Terms Relating to Plastics
- D3892 Practice for Packaging/Packing of Plastics
- D4894 Specification for Polytetrafluoroethylene (PTFE) Granular Molding and Ram Extrusion Materials
- 2.2 ISO Standards:⁴
- ISO 13000-1 Plastics—Polytetrafluorethylene (PTFE) Semi-Finished Products Part 1: Requirements and Designation

ISO 13000-2 Plastics—Polytetrafluorethylene (PTFE) Semi-Finished Products Part 2: Preparation of Specimens and Determination of Properties

3. Terminology

3.1 *Definitions*—Definitions are in accordance with Terminology D883 unless otherwise specified.

3.2 Definitions of Terms Specific to This Standard:

3.2.1 *lot, n*—one production run, or a uniform blend of two or more production runs.

3.2.2 *film*, *n*—full-width material received as finished film. 3.2.3 *Mil*, *n*— $\frac{1}{1000}$ (0.001) of an inch.

4. Classification

4.1 This specification covers four types of PTFE resin skived tape:

¹ This specification is under the jurisdiction of ASTM Committee D20 on Plastics and is the direct responsibility of Subcommittee D20.15 on Thermoplastic Materials (Section D20.15.12).

Current edition approved May 1, 2022. Published May 2022. Originally approved in 1974. Last previous edition approved in 2017 as D3308 - 12(2017). DOI: 10.1520/D3308-12R22.

² For referenced ASTM standards, visit the ASTM website, www.astm.org, or contact ASTM Customer Service at service@astm.org. For *Annual Book of ASTM Standards* volume information, refer to the standard's Document Summary page on the ASTM website.

 $^{^{3}\,\}mathrm{The}$ last approved version of this historical standard is referenced on www.astm.org.

⁴ Available from American National Standards Institute (ANSI), 25 W. 43rd St., 4th Floor, New York, NY 10036, http://www.ansi.org.

D3308 – 12 (2022)

TABLE 1 Width Tolerances for Skived Tape

Width		Tolerance		
mm	in.	mm	in.	
Up to 12.700	Up to 0.500	-0/+0.510	-0/+0.020	
12.701 to 25.400	0.501 to 1.000	-0/+0.640	-0/+0.025	
25.401 to 50.800	1.001 to 2.000	-0/+0.890	-0/+0.035	
50.801 to 76.200	2.001 to 3.000	-0/+1.905	-0/+0.075	
76.201 to 152.400	3.001 to 6.000	-0/+3.175	-0/+0.125	
152.401 or greater	6.001 or greater	-0/+6.350	-0/+0.250	

4.1.1 *Type I*—Premium; normally used for exacting electrical, mechanical, or chemical applications.

4.1.2 *Type II*—General purpose; for electrical, mechanical, and chemical applications not requiring premium material.

4.1.3 *Type III*—Commercial; for non-critical chemical, electrical, and mechanical applications.

4.1.4 *Type IV*—Utility; having no electrical requirements, and with mechanical properties at lower level.

4.2 Types I, II, III, and IV may be subdivided into two grades in accordance with the base resin used as follows:

4.2.1 Grade 1-Made only from virgin resin.

4.2.2 *Grade* 2—May be made using reprocessed resin, or a mixture of virgin and reprocessed resin.

4.3 A one-line system may be used to specify materials covered by this specification. The system uses predefined cells to refer to specific aspects of this specification, as illustrated below:

Sp	ecification				-
Standard Number Block	: Туре	: Grade	: Class	Special Notes	-)8-
s://standards.iteh.ai/cata	log/stand	lards/s	sist/5149)2194-	

2

Example: Specification D3308 - 06

For this example, the line callout would be: Specification D3308 - 06, I2, Oil and would specify a skived tape that has all of the properties listed for that Type and Grade, in the appropriate specified properties, tables, or both, in the specification identified. A comma is used as the separator between the Standard number and the Type. Separators are not needed between the Type and Grade, because they are, in turn, Roman numerals and Arabic digits.⁵ Provision for "Special Notes" is included so that other information can be provided when required. This example would be premium PTFE tape without special requirements. When Special Notes are used, they should be preceded by a comma.

5. Physical Requirements

5.1 The tape shall be made from unpigmented PTFE resin.

5.2 The length and width of the roll shall be as agreed upon between the purchaser and the seller. Width tolerances shall be in accordance with Table 1.

TABLE 2 Thickness Tolerances for Skived Tape

Thickness		Tolerance		
mm	in.	mm	in.	
0.013 to 0.025	0.0005 to 0.0010	±0.003	±0.0001	
0.028 to 0.076	0.0011 to 0.0030	±0.008	±0.0003	
0.091 to 0.254	0.0036 to 0.0100	±0.013	±0.0005	
0.257 to 0.381	0.0101 to 0.0150	±0.025	±0.0010	
0.384 to 1.016	0.0151 to 0.0400	±0.038	±0.0015	
1.019 to 3.175	0.0401 to 0.1250	±0.127	±0.0050	
>3.175	>0.1250	±0.254	±0.0100	

5.3 The melting point for all types of tape shall be 327 \pm 10°C (621 \pm 18°F).

5.4 The thickness tolerances for skived tape shall be as shown in Table 2.

5.5 Tensile strength and elongation shall meet the requirements shown in Table 3.

5.6 The requirements for specific gravity shall be as shown in Table 3.

5.7 The minimum required values for dielectric strength S (V/mil), shall be computed for applicable thicknesses of materials in accordance with the following formulas, where t is the thickness of the tape in mils.

Type I: S = 1000 times square root of (20/t)

Type II (thickness ≥ 0.003 in.): S = 840 times square root of (20/t)

Type II (thickness <0.003 in.): S = 630 times square root of (20/t)

Type III: S = 500 times square root of (20/t)

Type IV: No requirement for dielectric strength

5.8 The number of non-dielectric strength failure mode electrical flaws shall be determined in accordance with Test Method D1389.

6-4928-856e-ae5ed8c464b5/astm-d3308-1220 6. Sampling

6.1 Sampling shall be statistically adequate to satisfy the requirements of 9.4.

7. Number of Tests and Retests

7.1 One set of test specimens as prescribed in Section 8 shall be considered sufficient for testing each batch. The average result of the specimens shall conform to the requirements of this specification.

8. Test Methods

8.1 The properties enumerated in this specification shall be determined in accordance with the following test methods:

8.1.1 *Conditioning*—For those tests where conditioning is required, condition the test specimens in accordance with Procedure A of Practice D618 for a period of at least 4 h prior to test. If the test material has been exposed to temperatures below 20° C within 24 h prior to test, the conditioning shall be for at least 24 h.

8.1.2 *Test Conditions*—Conduct tests at the standard laboratory temperature of $23 \pm 2^{\circ}$ C (70 to 77°F). The maintenance of constant humidity is not necessary. In reference cases, the standard atmosphere, 50 ± 5 % relative humidity, shall apply.

⁵ See the ASTM Form and Style Manual. Available from ASTM Headquarters.